

MOSFET – N-Channel, QFET

200 V, 19.4 A, 150 mΩ

FQP19N20

Description

This N-Channel enhancement mode power MOSFET is produced using onsemi's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 19.4 A, 200 V, $R_{DS(on)}$ = 150 mΩ (Max.) @ V_{GS} = 10 V, I_D = 9.7 A
- Low Gate Charge (Typ. 31 nC)
- Low C_{RSS} (Typ. 30 pF)
- 100% Avalanche Tested

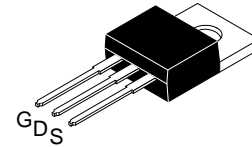
ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise noted)

Symbol	Parameter		FQP19N20	Unit
V_{DSS}	Drain-Source Voltage		200	V
I_D	Drain Current	– Continuous (T_C = 25°C)	19.4	A
		– Continuous (T_C = 100°C)	12.3	
I_{DM}	Drain Current	– Pulsed (Note 1)	78	A
V_{GSS}	Gate-Source Voltage		±30	V
E_{AS}	Single Pulsed Avalanche Energy (Note 2)		250	mJ
I_{AR}	Avalanche Current (Note 1)		19.4	A
E_{AR}	Repetitive Avalanche Energy (Note 1)		14	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		5.5	V/ns
P_D	Power Dissipation	(T_C = 25°C)	140	W
		– Derate above 25°C	1.12	
T_J, T_{STG}	Operating and Storage Temperature Range		–55 to +150	°C
T_L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

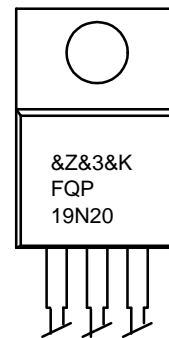
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. L = 1.0 mH, I_{AS} = 19.4 A, V_{DD} = 50 V, R_G = 25 Ω, starting T_J = 25°C.
3. I_{SD} ≤ 19.4 A, di/dt ≤ 300 A/μs, V_{DD} ≤ BV_{DSS} , starting T_J = 25°C.

V_{DSS}	$R_{DS(on)}$ MAX	I_D MAX
200 V	150 mΩ @ 10 V	19.4 A



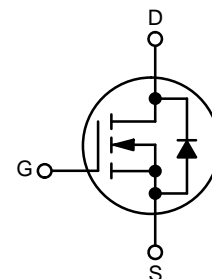
TO-220-3LD
CASE 340AT

MARKING DIAGRAM



&Z = Assembly Plant Code
 &3 = 3-Digit Date Code
 &K = 2-Digits Lot Run Traceability Code
 FQP19N20 = Specific Device Code

N-CHANNEL MOSFET



ORDERING INFORMATION

Part Number	Package	Shipping
FQP19N20	TO-220-3LD (Pb-Free, Halide Free)	1000 Units / Tube

FQP19N20

THERMAL CHARACTERISTICS

Symbol	Parameter	FQP19N20	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.89	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	200	–	–	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\text{ }\mu\text{A}$, Referenced to 25°C	–	0.18	–	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 200\text{ V}, V_{GS} = 0\text{ V}$	–	–	1	μA
		$V_{DS} = 160\text{ V}, T_C = 125^\circ\text{C}$	–	–	10	
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	–	–	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	–	–	-100	nA

ON CHARACTERISTICS

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	3.0	–	5.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 9.7\text{ A}$	–	0.12	0.15	Ω
g_{FS}	Forward Transconductance	$V_{DS} = 40\text{ V}, I_D = 9.7\text{ A}$	–	14.5	–	S

DYNAMIC CHARACTERISTICS

C_{iss}	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}, f = 1.0\text{ MHz}$	–	1220	1600	pF
C_{oss}	Output Capacitance		–	220	290	pF
C_{rss}	Reverse Transfer Capacitance		–	30	40	pF

SWITCHING CHARACTERISTICS

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 100\text{ V}, I_D = 19.4\text{ A}, R_G = 25\text{ }\Omega$ (Note 4)	–	20	50	ns
t_r	Turn-On Rise Time		–	190	390	ns
$t_{d(off)}$	Turn-Off Delay Time		–	55	120	ns
t_f	Turn-Off Fall Time		–	80	170	ns
Q_g	Total Gate Charge	$V_{DS} = 160\text{ V}, I_D = 19.4\text{ A}, V_{GS} = 10\text{ V}$ (Note 4)	–	31	40	nC
Q_{gs}	Gate-Source Charge		–	8.6	–	nC
Q_{gd}	Gate-Drain Charge		–	13.5	–	nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I _S	Maximum Continuous Drain–Source Diode Forward Current		–	–	19.4	A
I _{SM}	Maximum Pulsed Drain–Source Diode Forward Current		–	–	78	A
V _{SD}	Drain–Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 19.4 A	–	–	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 19.4 A, dI _F /dt = 100 A/μs	–	140	–	ns
Q _{rr}	Reverse Recovery Charge		–	0.69	–	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature

TYPICAL CHARACTERISTICS

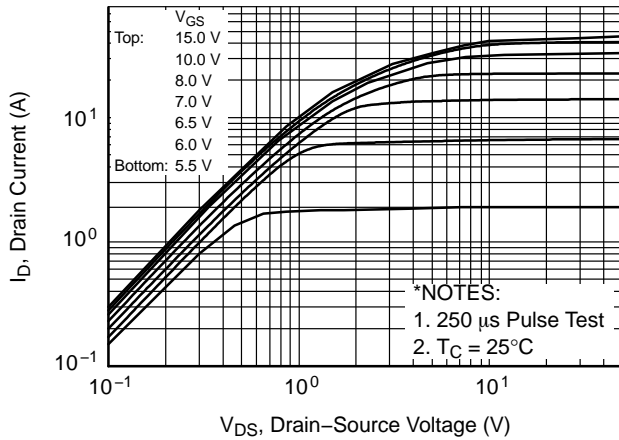


Figure 1. On-Region Characteristics

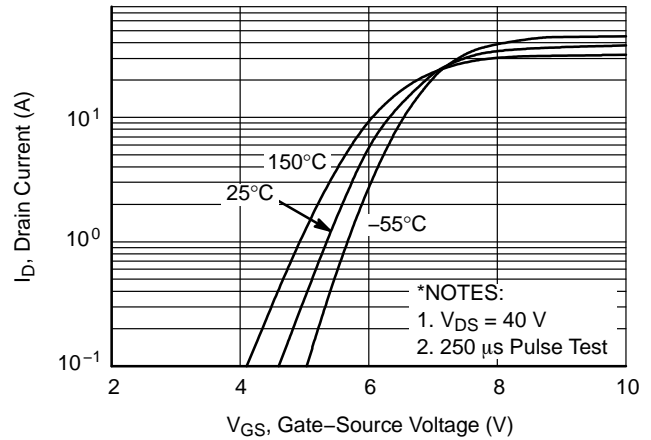


Figure 2. Transfer Characteristics

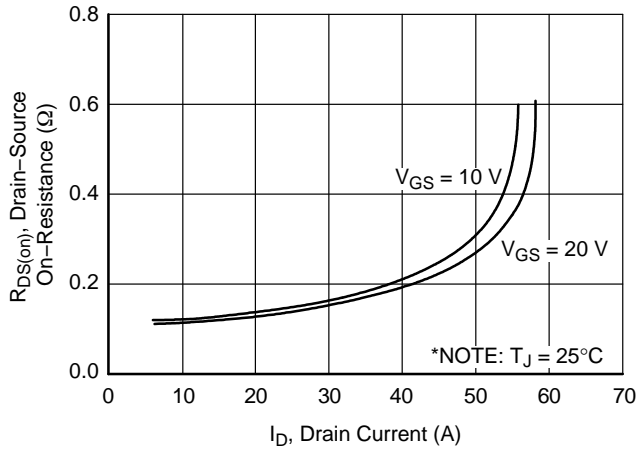


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

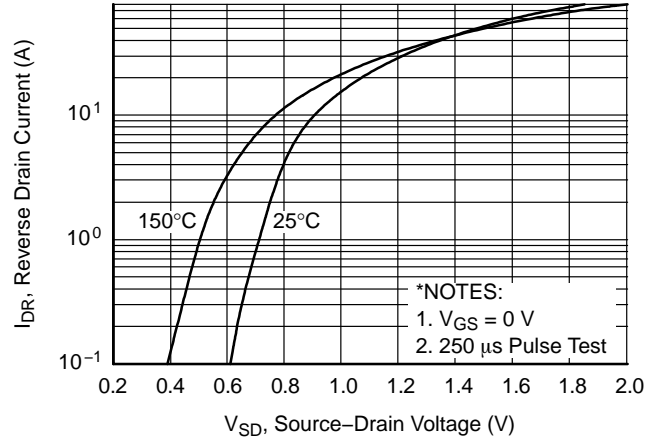


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

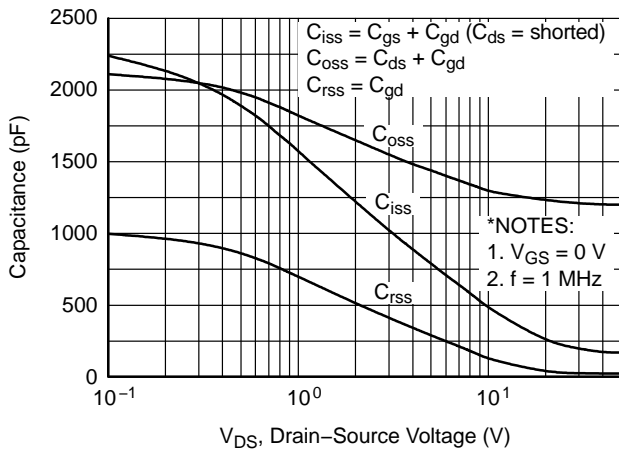


Figure 5. Capacitance Characteristics

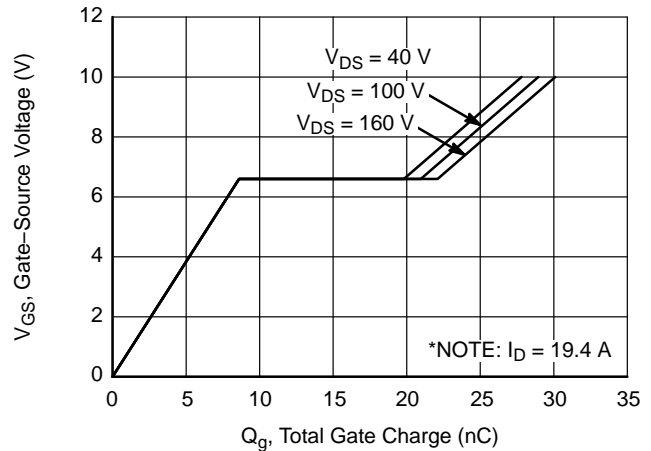


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (CONTINUED)

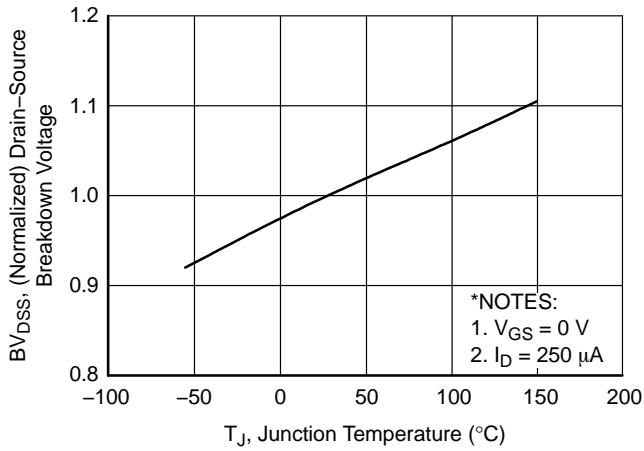


Figure 7. Breakdown Voltage Variation vs. Temperature

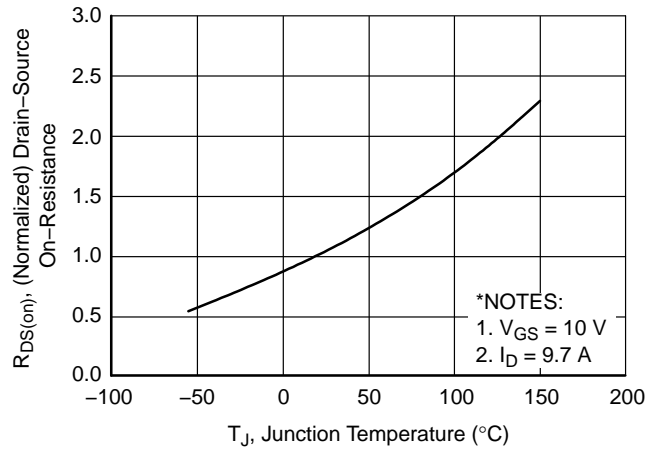


Figure 8. On-Resistance Variation vs. Temperature

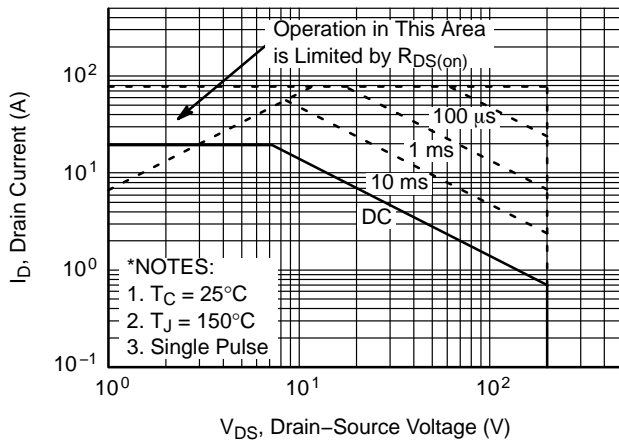


Figure 9. Maximum Safe Operating Area

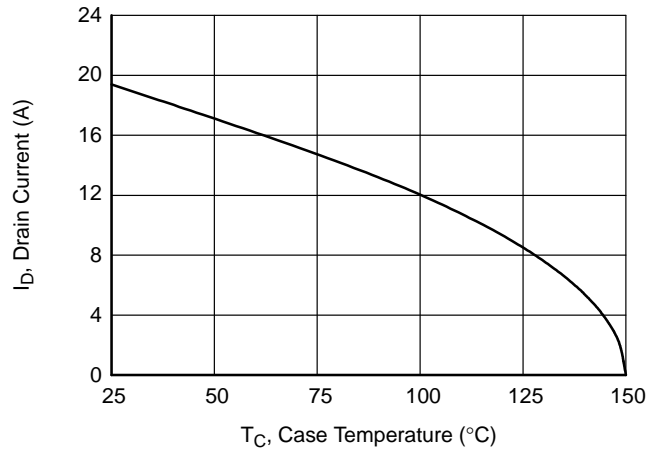


Figure 10. Maximum Drain Current vs. Case Temperature

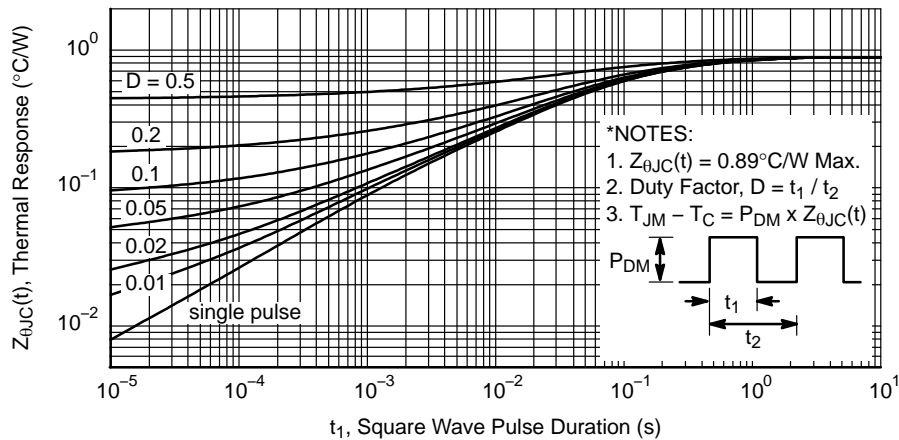
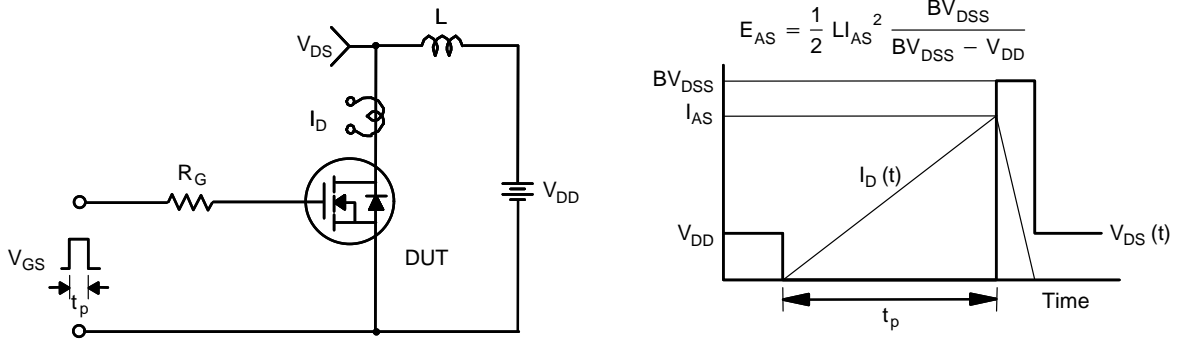
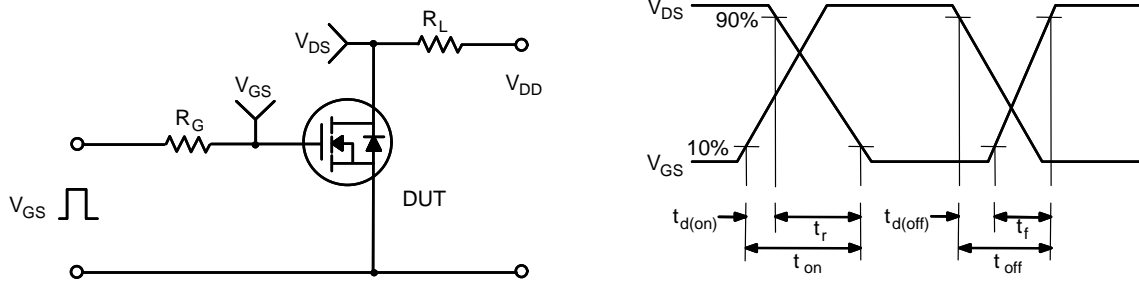
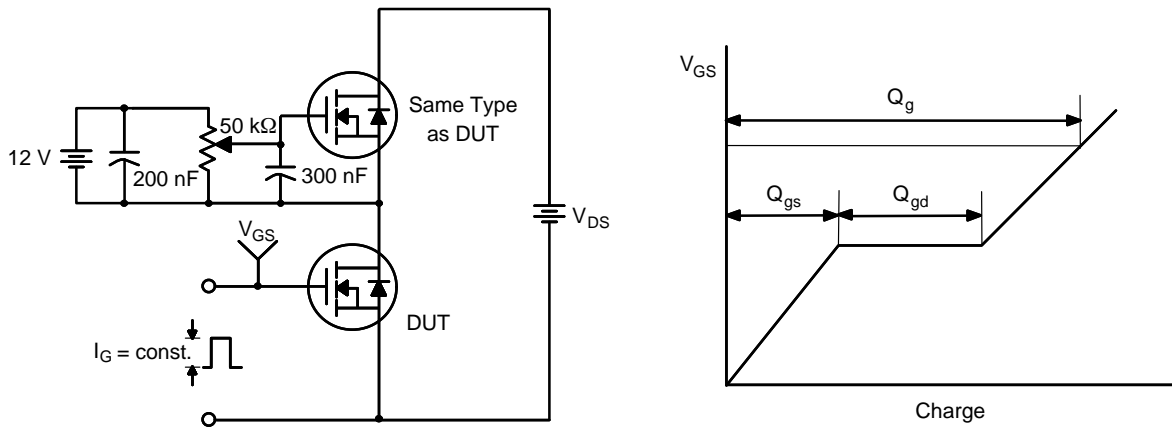


Figure 11. Transient Thermal Response Curve



FQP19N20

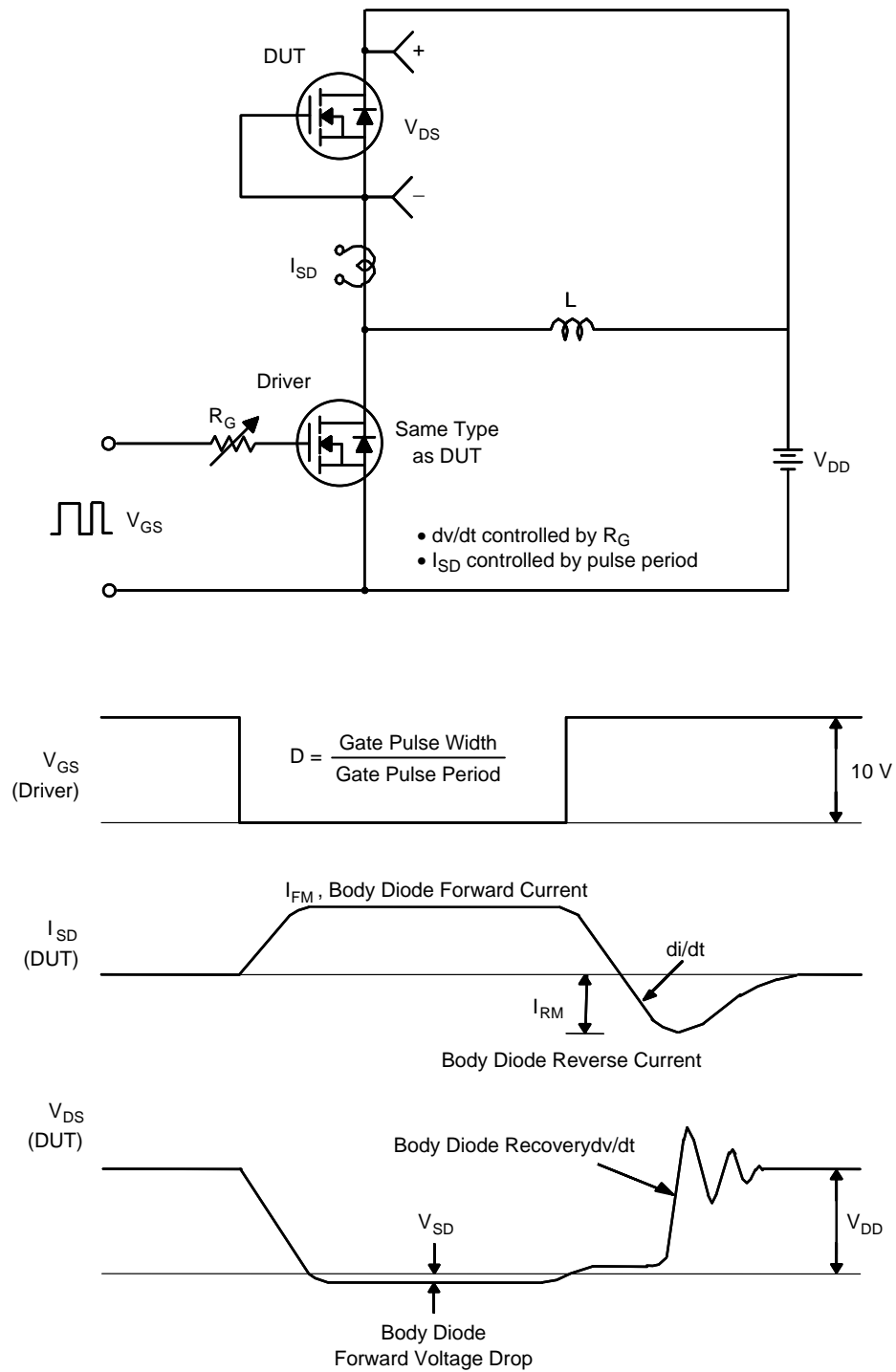
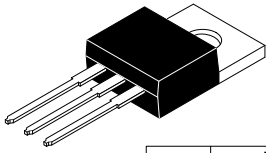


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms


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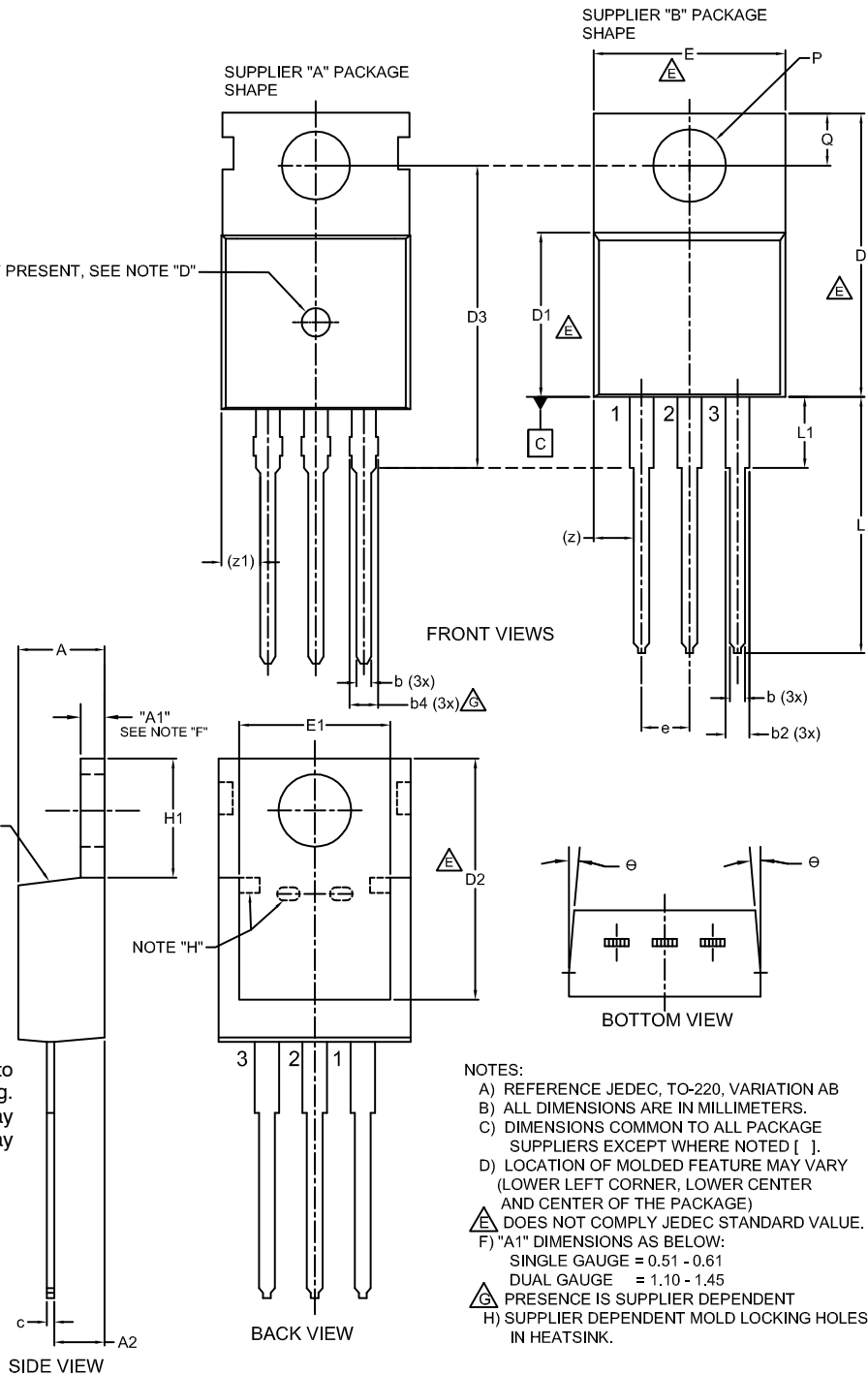
DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	4.00	--	4.70
A1	SEE NOTE "F"		
A2	2.10	--	2.85
b	0.55	--	1.00
b2	1.10	--	1.62
b4	1.42	--	1.62
c	0.36	--	0.60
D	13.90	--	16.30
D1	8.13	--	9.40
D2	11.50	--	14.30
D3	15.42	--	16.51
E	9.65	--	10.67
E1	7.59	--	8.65
e	2.40	--	2.67
H1	6.06	--	6.69
L	12.70	--	14.04
L1	2.70	--	4.10
P	3.50	--	4.00
Q	2.50	--	3.40
z	2.13 REF		
z1	2.06 REF		
θ	3°	--	5°

IF PRESENT, SEE NOTE "D"

GENERIC
MARKING DIAGRAM*


XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.



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